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## Polar3 ${ }^{\text {TM }}$ HiperFET ${ }^{\text {TM }}$ <br> Power MOSFET

N-Channel Enhancement Mode
Avalanche Rated
Fast Intrinsic Rectifier

IXFQ34N50P3 IXFH34N50P3


| Symbol | Test Conditions | Maximum Ratings |  |
| :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {DSs }}$ | $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}$ | 500 | V |
| $\mathrm{V}_{\text {DGR }}$ | $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$ to $150^{\circ} \mathrm{C}, \mathrm{R}_{\mathrm{GS}}=1 \mathrm{M} \Omega$ | 500 | V |
| $V_{\text {Gss }}$ | Continuous | $\pm 30$ | V |
| $\mathrm{V}_{\text {GSM }}$ | Transient | $\pm 40$ | V |
| $\mathrm{I}_{\mathrm{D} 25}$ | $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | 34 | A |
| $\underline{I_{\text {D }}}$ | $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$, Pulse Width Limited by $\mathrm{T}_{\mathrm{JM}}$ | 85 | A |
| $\mathrm{I}_{\mathrm{A}}$ | $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | 17 | A |
| $\mathrm{E}_{\text {AS }}$ | $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | 400 | mJ |
| dv/dt | $\mathrm{I}_{\mathrm{S}} \leq \mathrm{I}_{\mathrm{DM}}, \mathrm{V}_{\mathrm{DD}} \leq \mathrm{V}_{\mathrm{DSS}}, \mathrm{T}_{\mathrm{J}} \leq 150^{\circ} \mathrm{C}$ | 35 | V/ns |
| $\mathrm{P}_{\mathrm{D}}$ | $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | 695 | W |
| $\mathrm{T}_{J}$ |  | $-55 \ldots+150$ | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\text {JM }}$ |  | 150 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\text {stg }}$ |  | $-55 \ldots+150$ | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\mathrm{L}}$ | Maximum Lead Temperature for Soldering | 300 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\text {sold }}$ | 1.6 mm (0.062in.) from Case for 10s | 260 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{M}_{\mathrm{d}}$ | Mounting Torque | 1.13 / 10 | Nm/lb.in. |
| Weight | TO-3P | 5.5 | g |
|  | TO-247 | 6.0 | g |


| Symbol Test Conditions <br> ( $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$ Unless Otherwise Specified) |  | Characteristic Values |  |  |
| :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. |
| $\mathrm{BV}_{\mathrm{Dss}}$ | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=1 \mathrm{~mA}$ | 500 |  | V |
| $\mathrm{V}_{\text {GS(th) }}$ | $\mathrm{V}_{\mathrm{DS}}=\mathrm{V}_{\mathrm{GS}}, \mathrm{I}_{\mathrm{D}}=4 \mathrm{~mA}$ | 3.0 |  | 5.0 V |
| $\mathrm{I}_{\text {Gss }}$ | $\mathrm{V}_{\mathrm{GS}}= \pm 30 \mathrm{~V}, \mathrm{~V}_{\mathrm{DS}}=0 \mathrm{~V}$ |  |  | $\pm 100 \mathrm{nA}$ |
| $\mathrm{I}_{\text {DS }}$ | $\mathrm{V}_{\mathrm{DS}}=\mathrm{V}_{\mathrm{DSS}}, \mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}$ |  |  | $\begin{array}{rr} 50 & \mu \mathrm{~A} \\ 1.5 & \mathrm{~mA} \end{array}$ |
| $\underline{\mathbf{R}_{\text {DS(on) }}}$ | $\mathrm{V}_{\mathrm{GS}}=10 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=0.5 \cdot \mathrm{I}_{\mathrm{D} 2}$ |  |  | $180 \mathrm{~m} \Omega$ |

$$
\begin{aligned}
& \mathrm{V}_{\mathrm{Dss}}=500 \mathrm{~V} \\
& \mathrm{I}_{\mathrm{D} 55}=34 \mathrm{~A} \\
& \mathrm{R}_{\mathrm{DS}(\mathrm{on})} \leq 180 \mathrm{~m} \Omega
\end{aligned}
$$

TO-3P (IXFQ)


TO-247 (IXFH)


$$
G=\text { Gate } \quad D \quad=\text { Drain }
$$

$$
S=\text { Source } \quad T a b=\text { Drain }
$$

## Features

- Fast Intrinsic Rectifier
- Avalanche Rated
- Low $\mathrm{R}_{\mathrm{DS}(\mathrm{ON})}$ and $\mathrm{Q}_{\mathrm{G}}$
- Low Package Inductance


## Advantages

- High Power Density
- Easy to Mount
- Space Savings


## Applications

- Switch-Mode and Resonant-Mode Power Supplies
- DC-DC Converters
- Laser Drivers
- AC and DC Motor Drives
- Robotics and Servo Controls

IXFQ34N50P3
IXFH34N50P3

Symbol Test Conditions

| ( $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$ Unless Otherwise Specified) | Min. | Typ. | Max. |
| :---: | :---: | :---: | :---: |
| $\mathrm{g}_{\mathrm{fs}} \quad \mathrm{V}_{\mathrm{DS}}=20 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=0.5 \cdot \mathrm{I}_{\mathrm{D} 25}$, Note 1 | 20 | 33 | S |
| $\left.\begin{array}{l}\mathrm{C}_{\text {iss }} \\ \mathrm{C}_{\text {oss }} \\ \mathrm{C}_{\text {rss }}\end{array}\right\} \quad \mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{DS}}=25 \mathrm{~V}, \mathrm{f}=1 \mathrm{MHz}$ |  | $\begin{array}{r} 3260 \\ 390 \\ 7.8 \end{array}$ | pF pF pF |
| $\mathbf{R}_{\text {Gi }} \quad$ Gate Input Resistance |  | 1.5 | $\Omega$ |
|  |  | $\begin{array}{r} 23 \\ 57 \\ 40 \\ 9 \end{array}$ | ns ns ns ns |
| $\left.\begin{array}{l} \mathbf{Q}_{\mathrm{g}(\mathrm{on})} \\ \mathbf{Q}_{\mathrm{gs}} \\ \mathbf{Q}_{\mathrm{gd}} \end{array}\right\} \mathrm{V}_{\mathrm{GS}}=10 \mathrm{~V}, \mathrm{~V}_{\mathrm{DS}}=0.5 \cdot \mathrm{~V}_{\mathrm{DSS}}, \mathrm{I}_{\mathrm{D}}=0.5 \cdot \mathrm{I}_{\mathrm{D} 25}$ |  | 60 17 21 | nC nC nC |
| $\begin{aligned} & \mathbf{R}_{\mathrm{thJc}} \\ & \mathbf{R}_{\mathrm{thhcs}} \\ & \hline \end{aligned}$ |  | 0.25 | $\begin{array}{r} 0.18{ }^{\circ} \mathrm{C} / \mathrm{W} \\ { }^{\circ} \mathrm{C} / \mathrm{W} \end{array}$ |

## Source-Drain Diode

Symbol
Test Conditions
Characteristic Values

| ( $\mathrm{T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$ Unless Otherwise Specified) | Min. ${ }^{\text {a }}$ Typ. | Max. |
| :---: | :---: | :---: |
| $\mathrm{I}_{\mathrm{s}} \quad \mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}$ |  | 34 A |
| $\mathrm{I}_{\text {SM }} \quad$ Repetitive, Pulse Width Limited by $\mathrm{T}_{\text {JM }}$ |  | 136 A |
| $\mathrm{V}_{\text {SD }} \quad \mathrm{I}_{\mathrm{F}}=\mathrm{I}_{\mathrm{S}}, \mathrm{V}_{\text {GS }}=0 \mathrm{~V}$, Note 1 |  | 1.4 V |
| $\left.\begin{array}{l} \mathbf{t}_{\mathrm{rr}} \\ \mathrm{I}_{\mathrm{RM}} \\ \mathrm{Q}_{\mathrm{RM}} \end{array}\right\} \begin{aligned} & \mathrm{I}_{\mathrm{F}}=17 \mathrm{~A},-\mathrm{di} / \mathrm{dt}=100 \mathrm{~A} / \mu \mathrm{s} \\ & \mathrm{~V}_{\mathrm{R}}=100 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V} \end{aligned}$ |  | $250 \begin{array}{r}\text { ns } \\ \text { A } \\ \\ \mu \mathrm{C}\end{array}$ |

Note 1. Pulse test, $\mathrm{t} \leq 300 \mu \mathrm{~s}$, duty cycle, $\mathrm{d} \leq 2 \%$.

TO-3P Outline


TO-247 Outline


Terminals: 1 - Gate 2 - Drain
3 - Source

| Dim. | Millimeter |  | Inches |  |
| :---: | :---: | :---: | :---: | :---: |
|  | Min. | Max. | Min. | Max. |
| A | 4.7 | 5.3 | . 185 | . 209 |
| $\mathrm{A}_{1}$ | 2.2 | 2.54 | . 087 | . 102 |
| $\mathrm{A}_{2}$ | 2.2 | 2.6 | . 059 | . 098 |
| b | 1.0 | 1.4 | . 040 | . 055 |
| $\mathrm{b}_{1}$ | 1.65 | 2.13 | . 065 | . 084 |
| $\mathrm{b}_{2}$ | 2.87 | 3.12 | . 113 | . 123 |
| C | . 4 | . 8 | . 016 | . 031 |
| D | 20.80 | 21.46 | . 819 | . 845 |
| E | 15.75 | 16.26 | . 610 | . 640 |
| e | 5.20 | 5.72 | 0.205 | 0.225 |
| L | 19.81 | 20.32 | . 780 | . 800 |
| L1 |  | 4.50 |  | . 177 |
| $\varnothing \mathrm{P}$ | 3.55 | 3.65 | . 140 | . 144 |
| Q | 5.89 | 6.40 | 0.232 | 0.252 |
| R | 4.32 | 5.49 | . 170 | . 216 |
| S | 6.15 |  |  |  |

IXYS Reserves the Right to Change Limits, Test Conditions, and Dimensions.

| IXYS MOSFETs and IGBTs are covered | 4,835,592 | 4,931,844 | 5,049,961 | 5,237,481 | 6,162,665 | 6,404,065 B1 | 6,683,344 | 6,727,585 | 7,005,734 B2 | 7,157,338B2 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| by one or more of the following U.S. patents: | 4,860,072 | 5,017,508 | 5,063,307 | 5,381,025 | 6,259,123 B1 | 6,534,343 | 6,710,405 B2 | 6,759,692 | 7,063,975 B2 |  |
|  | 4,881,106 | 5,034,796 | 5,187,117 | 5,486,715 | 6,306,728 B1 | 6,583,505 | 6,710,463 | 6,771,478 B2 | 7,071,537 |  |

IXFQ34N50P3 IXFH34N50P3

Fig. 1. Output Characteristics $@ \mathrm{~T}_{\mathrm{J}}=\mathbf{2 5}{ }^{\circ} \mathrm{C}$


Fig. 3. Output Characteristics $@ \mathrm{~T}_{\mathrm{J}}=125^{\circ} \mathrm{C}$


Fig. 5. $\mathrm{R}_{\mathrm{DS}(o n)}$ Normalized to $\mathrm{I}_{\mathrm{D}}=17 \mathrm{~A}$ Value vs.


Fig. 2. Extended Output Characteristics $@ \mathrm{~T}_{\mathrm{J}}=\mathbf{2 5} \mathbf{5}^{\circ} \mathrm{C}$


Fig. 4. $R_{\mathrm{DS}(o n)}$ Normalized to $\mathrm{I}_{\mathrm{D}}=17 \mathrm{~A}$ Value vs. Junction Temperature


Fig. 6. Maximum Drain Current vs.


Fig. 7. Input Admittance


Fig. 9. Forward Voltage Drop of Intrinsic Diode


Fig. 11. Capacitance


Fig. 8. Transconductance


Fig. 10. Gate Charge


Fig. 12. Forward-Bias Safe Operating Area


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Fig. 13. Maximum Transient Thermal Impedance


